1.1MHz, Precision, Rail-to-Rail I/O CMOS Operational Amplifier

1 FEATURES

- **HIGH GAIN BANDWIDTH:1.1MHz**
- **RAIL-TO-RAIL INPUT AND OUTPUT**
  ±4.5mV Max Vos
- **INPUT VOLTAGE RANGE: -0.1V to +5.6V with Vs = 5.5V**
- **SUPPLY RANGE: +2.5V to +5.5V**
- **SPECIFIED UP TO +125°C**
- **PACKAGES: SOIC-14、TSSOP-14**

2 APPLICATIONS

- **SENSORS**
- **PHOTODIODE AMPLIFICATION**
- **ACTIVE FILTERS**
- **TEST EQUIPMENT**
- **DRIVING A/D CONVERTERS**

3 DESCRIPTIONS

The RS324A products offer low voltage operation and rail-to-rail input and output, as well as excellent speed/power consumption ratio, providing an excellent bandwidth (1.1MHz) and slew rate of 0.5V/us. The op-amps are unity gain stable and feature an ultra-low input bias current.

The RS324A has lower offset, which is guaranteed not upper than ±4.5mV at 25°C with Vs = 5V, V_{CM} = Vs/2.

The devices are ideal for sensor interfaces, active filters and portable applications. The RS324A families of operational amplifiers are specified at the full temperature range of -40°C to +125°C under single or dual power supplies of 2.5V to 5.5V.

Device Information (1)

PART NUMBER	PACKAGE	BODY SIZE(NOM)
RS324A	SOIC-14(SOP14)	8.65mm×3.90mm
	TSSOP-14	5.00mm×4.40mm

(1) For all available packages, see the orderable addendum at the end of the data sheet

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4 Revision History

Note: Page numbers for previous revisions may different from page numbers in the current version.

VERSION	Change Date	Change Item
A.2	2022/11/08	1. Update Package Qty on Page 4@RevA.1 2.Added TAPE AND REEL INFORMATION

5 PACKAGE/ORDERING INFORMATION (1)

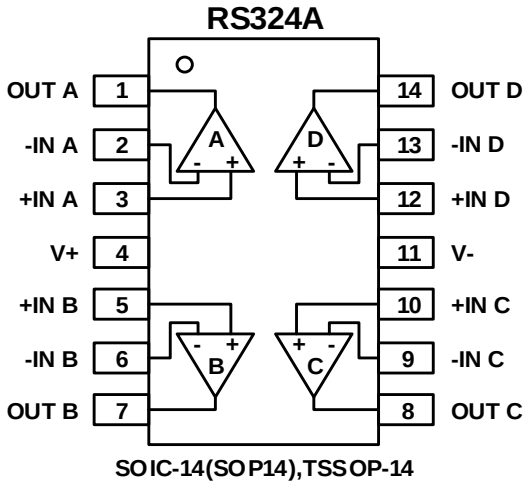
PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING (2)	PACKAGE OPTION
RS324A	RS324AXP	-40°C ~125°C	SOIC-14(SOP14)	RS324A	Tape and Reel,4000
	RS324AXQ	-40°C ~125°C	TSSOP-14	RS324A	Tape and Reel,4000

NOTE:

(1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.

(2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.

6 Pin Configuration and Functions (Top View)



SOIC-14(SOP14),TSSOP-14

Pin Description

NAME	PIN	I/O (1)	DESCRIPTION
	SOIC-14(SOP14)/TSSOP-14		
-INA	2	I	Inverting input, channel A
+INA	3	I	Noninverting input, channel A
-INB	6	I	Inverting input, channel B
+INB	5	I	Noninverting input, channel B
-INC	9	I	Inverting input, channel C
+INC	10	I	Noninverting input, channel C
-IND	13	I	Inverting input, channel D
+IND	12	I	Noninverting input, channel D
OUTA	1	O	Output, channel A
OUTB	7	O	Output, channel B
OUTC	8	O	Output, channel C
OUTD	14	O	Output, channel D
V-	11	-	Negative (lowest) power supply
V+	4	-	Positive (highest) power supply

(1) I = Input, O = Output.

7 SPECIFICATIONS

7.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) (1)

			MIN	MAX	UNIT
Voltage	Supply, V_S=(V+) - (V-)			7	V
	Signal input pin (2)		(V-)-0.5	(V+) +0.5	
	Signal output pin (3)		(V-)-0.5	(V+) +0.5	
Current	Signal input pin (2)		-10	10	mA
	Signal output pin (3)		-140	140	mA
	Output short-circuit (4)		Continuous		
θ_{JA}	Package thermal impedance (5)	SOIC-14(SOP14)		104.5	°C/W
		TSSOP14		89.21	
Temperature	Operating range, T_A		-40	125	°C
	Junction, T_J (6)		-40	150	
	Storage, T_{stg}		-65	150	

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.
(3) Output terminals are diode-clamped to the power-supply rails. Output signals that can swing more than 0.5V beyond the supply rails should be current-limited to ±140mA or less.
(4) Short-circuit to ground, one amplifier per package.
(5) The package thermal impedance is calculated in accordance with JESD-51.
(6) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

7.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001(1)	±3000	V
		Machine Model (MM)	±200	

(1) JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.

ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

7.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Supply voltage，V_S= (V+) - (V-)	Single-supply	2.5		5.5	V
	Dual-supply	±1.25		±2.75	

7.4 ELECTRICAL CHARACTERISTICS

(At T_A = +25°C, V_S=5V, R_L = 10kΩ connected to V_S/2, and V_{OUT} = V_S/2, Full [9] = -40°C to +125°C, unless otherwise noted.) [1]

PARAMETER		CONDITIONS	T_J	RS324A			
				MIN[2]	TYP[3]	MAX[2]	UNIT
POWER SUPPLY							
Vs	Operating Voltage Range		25°C	2.5		5.5	V
IQ	Quiescent Current/Amplifier		25°C		60	110	uA
PSRR	Power-Supply Rejection Ratio	V_S=2.5V to 5.5V, V_{CM}=(V-)+0.5V	25°C	74	90		dB
			Full	65			
INPUT							
Vos	Input Offset Voltage	V_{CM}=0V to 3.5V	25°C	-4.5	±0.8	4.5	mV
Vos T_C	Input Offset Voltage Average Drift		Full		±2		uV/°C
IB	Input Bias Current [4] [5]		25°C		±10	±100	pA
Ios	Input Offset Current [4]		25°C		±1	±10	pA
V_{CM}	Common-Mode Voltage Range	V_S= 5.5V	25°C	-0.1		5.6	V
CMRR	Common-Mode Rejection Ratio	V_S= 5.5V, V_{CM}=-0.1V to 4V	25°C	74	90		dB
			Full	68			
		V_S= 5.5V, V_{CM}=-0.1V to 5.6V	25°C	63	80		
			Full	57			
OUTPUT							
A_{OL}	Open-Loop Voltage Gain	R_L=2KΩ, Vo=0.15V to 4.85V	25°C	85	105		dB
			Full	80			
		R_L=10KΩ, Vo= 0.05V to 4.95V	25°C	88	110		
			Full	83			
	Output Swing From Rail	R_L=2KΩ	25°C		25		mV
		R_L=10KΩ			8		
I_{OUT}	Output Short-Circuit Current [6] [7]		25°C		130		mA
FREQUENCY RESPONSE							
SR	Slew Rate [8]		25°C		0.5		V/us
GBP	Gain-Bandwidth Product		25°C		1.1		MHz
PM	Phase Margin		25°C		64		°
ts	Setting Time,0.1%				1.3		us
	Overload Recovery Time	V_{IN}·Gain≥V_S			2.3		us
NOISE							
e_n	Input Voltage Noise Density	f = 1KHz	25°C		22		nV/$\sqrt{Hz}$
		f = 10KHz	25°C		20		nV/$\sqrt{Hz}$

(1) Electrical table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device.
(2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.
(3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.
(4) This parameter is ensured by design and/or characterization and is not tested in production.
(5) Positive current corresponds to current flowing into the device.
(6) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A. The maximum allowable power dissipation at any ambient temperature is PD = ($T_{J(MAX)}$ - T_A) / $R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.
(7) Short circuit test is a momentary test.
(8) Number specified is the slower of positive and negative slew rates.
(9) Specified by characterization only.

7.5 TYPICAL CHARACTERISTICS

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At T_A = +25°C, Vs=5V, R_L = 10kΩ connected to $V_S/2$, V_{OUT} = $V_S/2$, unless otherwise noted.

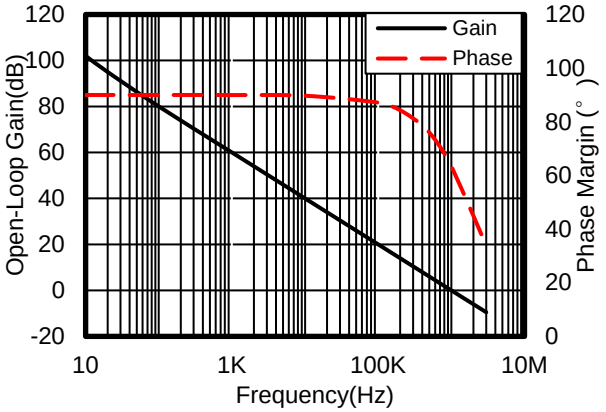


Figure 1. Open-Loop Gain and Phase vs Frequency

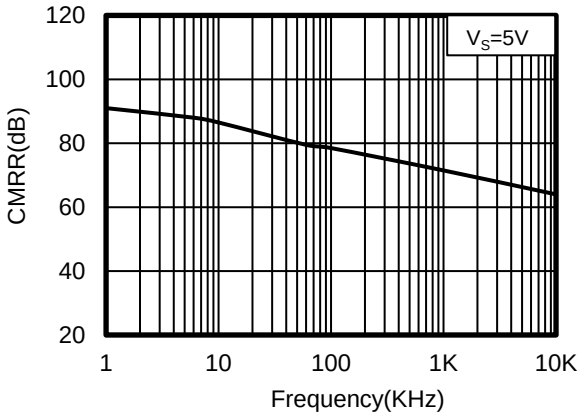


Figure 2. Common-Mode Rejection Ratio vs Frequency

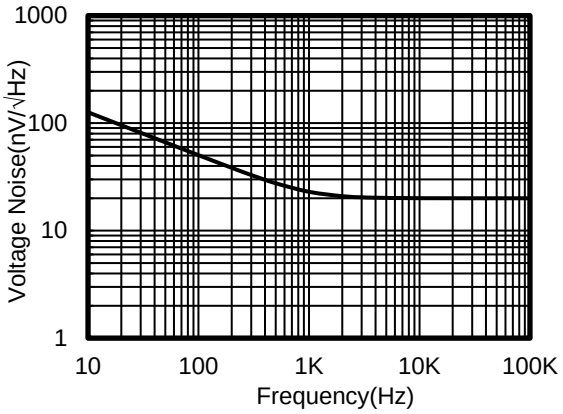


Figure 3. Input Voltage Noise Spectral Density vs Frequency

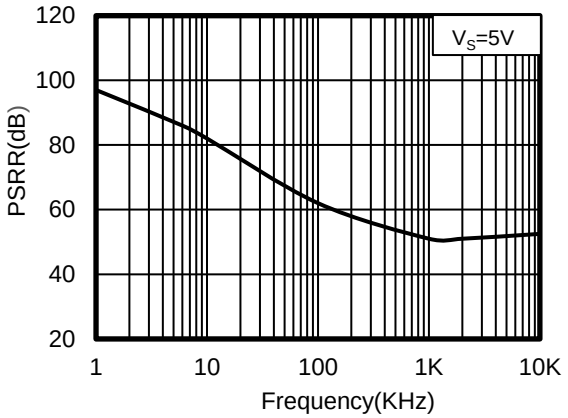


Figure 4. Power-Supply Rejection Ratio vs Frequency

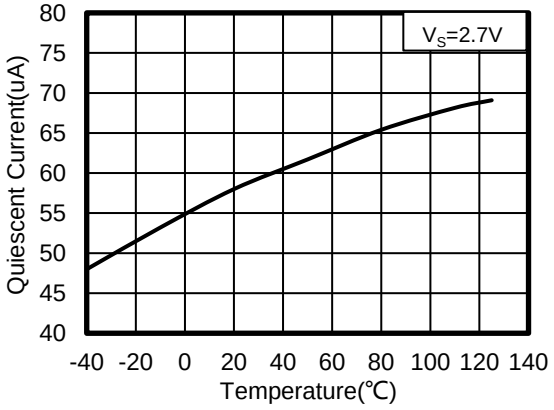


Figure 5. Quiescent Current vs Temperature

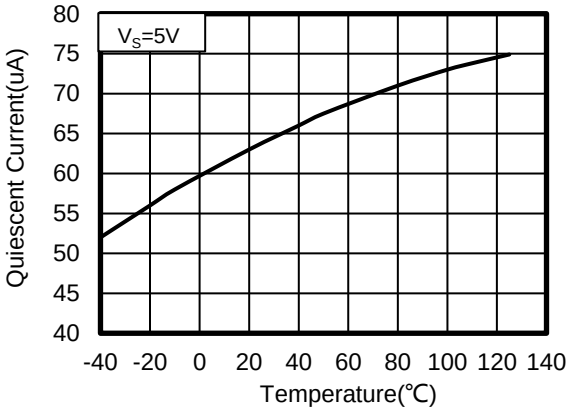


Figure 6. Quiescent Current vs Temperature

TYPICAL CHARACTERISTICS

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At T_A = +25°C, Vs=5V, R_L = 10kΩ connected to $V_S/2$, V_{OUT} = $V_S/2$, unless otherwise noted.

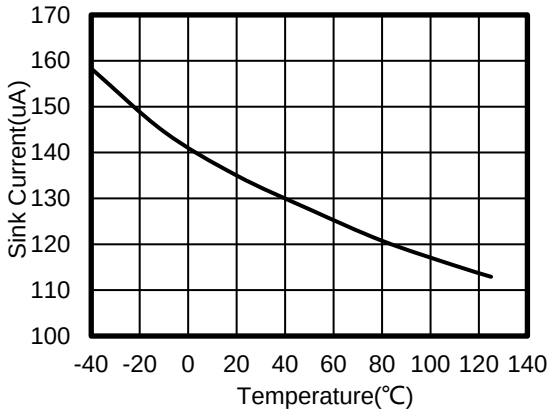


Figure 7. Sink Current vs Temperature

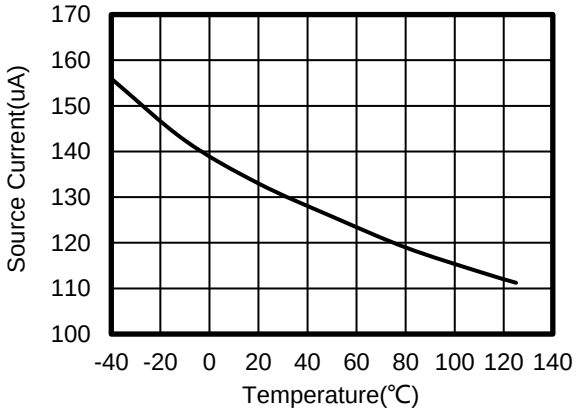


Figure 8. Source Current vs Temperature

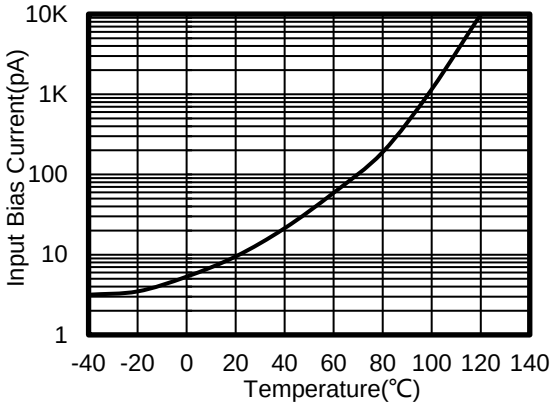


Figure 9. Input Bias Current vs Temperature

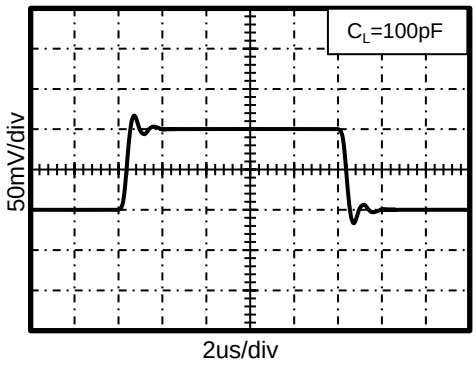


Figure 10. Small-Signal Step Response

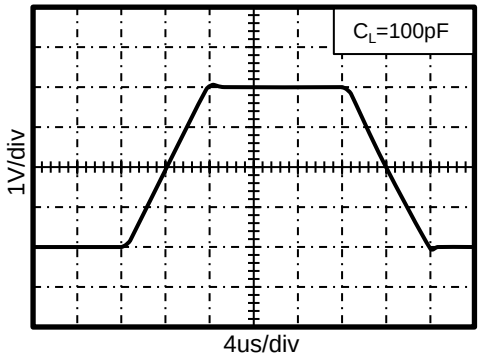


Figure 11. Large-Signal Step Response

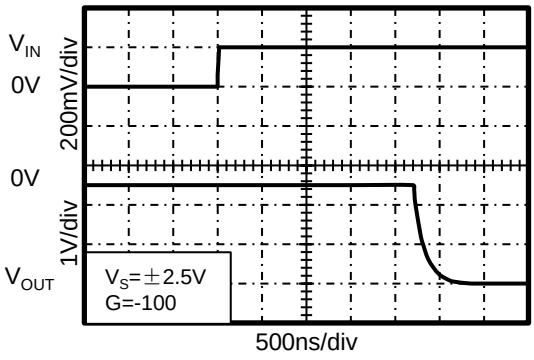


Figure 12. Positive Overvoltage Recovery

TYPICAL CHARACTERISTICS

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At T_A = +25°C, Vs=5V, R_L = 10kΩ connected to $V_S/2$, V_{OUT} = $V_S/2$, unless otherwise noted.

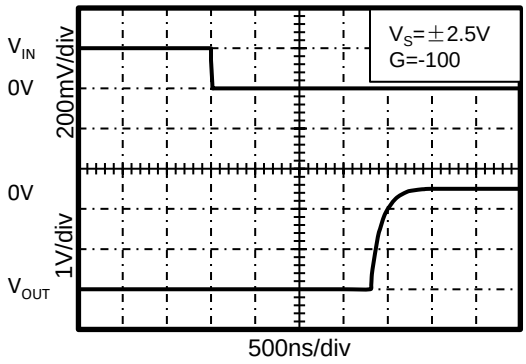


Figure 13. Negative Overvoltage Recovery

8 Application and Implementation

Information in the following applications sections is not part of the RUNIC component specification, and RUNIC does not warrant its accuracy or completeness. RUNIC's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 APPLICATION NOTES

The RS324A are high precision, rail-to-rail operational amplifiers that can be run from a single-supply voltage 2.5V to 5.5V (±1.25V to ±2.75V). Supply voltages higher than 7V (absolute maximum) can permanently damage the amplifier. Rail-to-rail input and output swing significantly increases dynamic range, especially in low-supply applications. Good layout practice mandates use of a 0.1uF capacitor place closely across the supply pins.

8.2 LAYOUT GUIDELINS

Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1uF capacitor closely across the supply pins. These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI susceptibility.

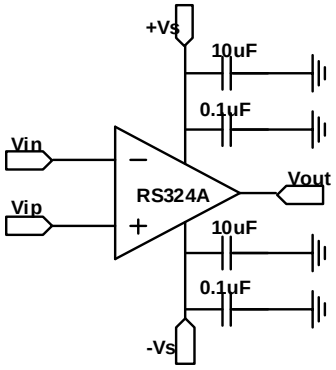


Figure 14. Amplifier with Bypass Capacitors

8.3 INSTRUMENTATION AMPLIFIER

In the three-op amp, instrumentation amplifier configuration shown in Figure 15.

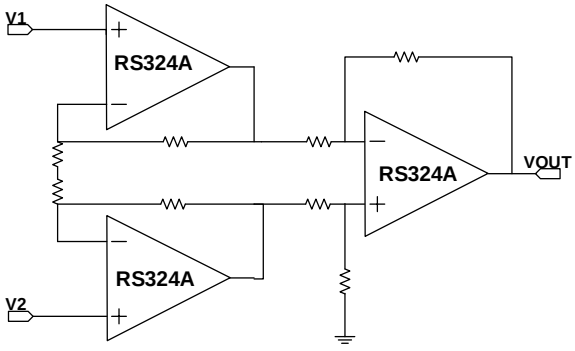
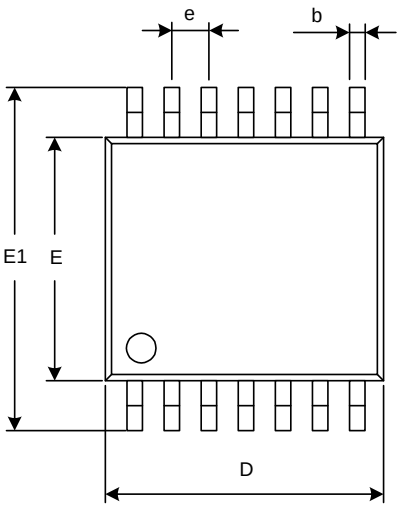
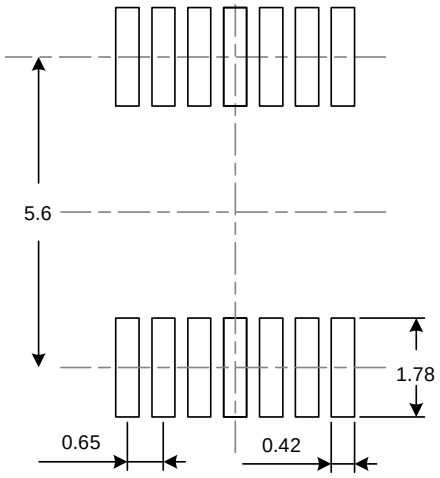


Figure 15. Amplifier instrumentation amplifier

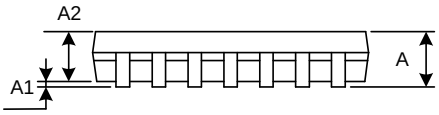
9 PACKAGE OUTLINE DIMENSIONS

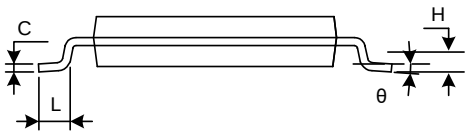
TSSOP-14





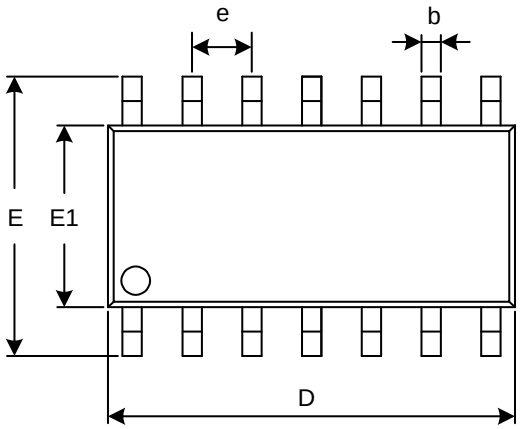
RECOMMENDED LAND PATTERN (Unit: mm)

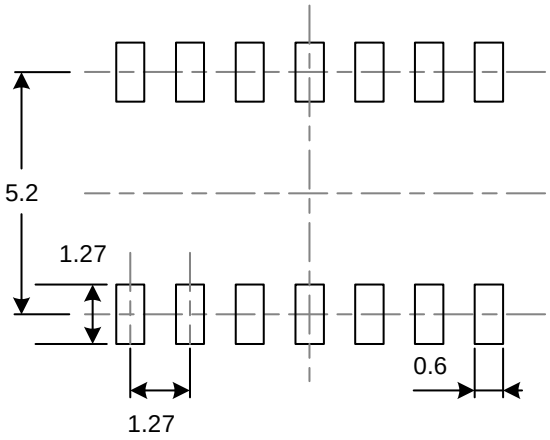




Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.860	5.100	0.191	0.201
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650(BSC)		0.026(BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

SOIC-14(SOP14)





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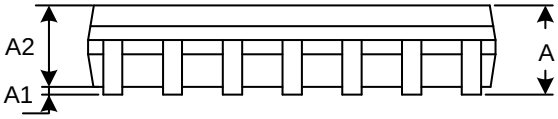
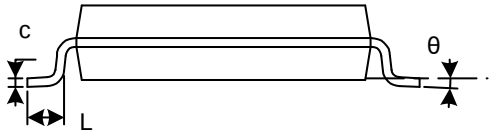




Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.310	0.510	0.012	0.020
c	0.100	0.250	0.004	0.010
D	8.450	8.850	0.333	0.348
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

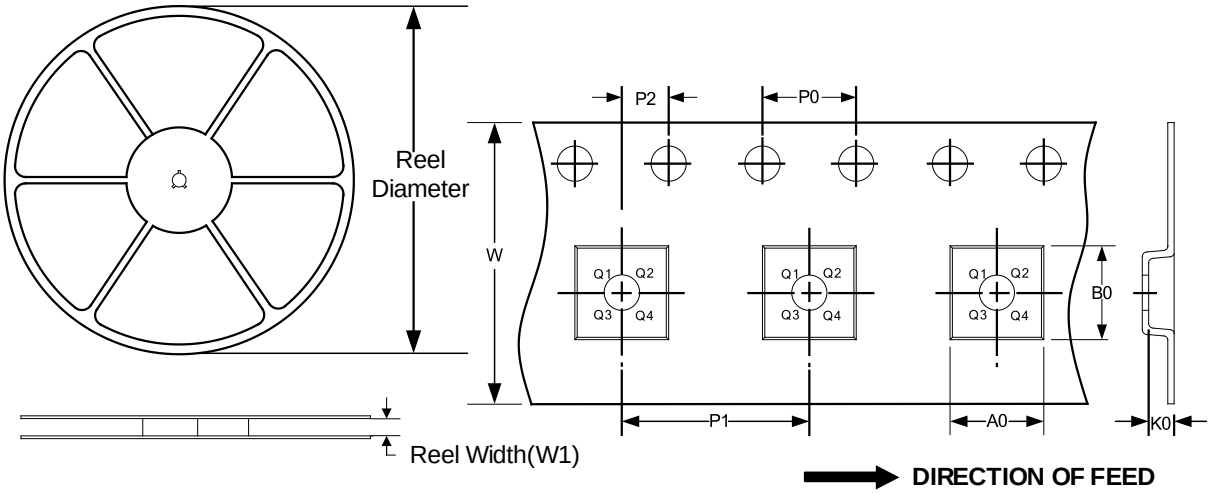
NOTE:

A. All linear dimension is in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
D. BSC: Basic Dimension. Theoretically exact value shown without tolerances.

10 TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOIC-14(SOP14)	13"	16.4	6.60	9.30	2.10	4.0	8.0	2.0	16.0	Q1
TSSOP-14	13"	12.4	6.95	5.60	1.20	4.0	8.0	2.0	12.0	Q1

NOTE:
1. All dimensions are nominal.
2. Plastic or metal protrusions of 0.15mm maximum per side are not included.

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